# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SHIH-HSIUNG HUANG	05/24/2021
YING-CHENG WU	05/24/2021
CHIEN-MING WU	05/24/2021
KAI-YIN LIU	05/24/2021

### **RECEIVING PARTY DATA**

Name:	REALTEK SEMICONDUCTOR CORPORATION	
Street Address:	NO. 2, INNOVATION ROAD II, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	Taiwan ROC	
Postal Code:	300	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17333063

## **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	JUSTIN KING
SIGNATURE:	/Justin King/
DATE SIGNED:	05/28/2021

**Total Attachments: 2** source=a#page1.tif source=a#page2.tif

PATENT REEL: 056379 FRAME: 0643

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# **ASSIGNMENT**

WHEREAS, I(we), SHIH-HSIUNG HUANG, YING-CHENG WU, CHIEN-MING WU and KAI-YIN LIU whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled.

# FLASH ANALOG TO DIGITAL CONVERTER AND CALIBRATION METHOD

(hereinafter referred to as the INVENTION) for which an a is executed on even date herewith unless at least one of the United States Design Patent was executed on:  Executed on:  Serial No.:  established by PCT International Patent Applicat	ne following is checked:	etters Patent /Utility Patent  designating the		
United States of America  issued on as U.S. Patent No.		araignamig mu		
WHEREAS, REALTEK SEMICONDUCTOR CORPORATION whose post office address is No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan (R.O.C.) hereinafter referred to as ASSIGNEE is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions;				
NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention.				
ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment;				
ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE'S expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR'S possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR'S heirs, executors, administrators and other legal representatives.				
ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.				
ASSIGNOR NAME SHIH-HSIUNG HUANG	Address No. 2, Innovation Road II Hsinchu 300, Taiwan (R.O.C	, Hsinchu Science Park,		
Signature of Assignor  Ship Hary Huard	Date of Signature May 24, 20.	21		
Name of Witness (optional)	Name of Witness (optional)			
Signature of Witness (optional)	Signature of Witness (Optional)			

PATENT REEL: 056379 FRAME: 0644

ASSIGNOR NAME	Address	
YING-CHENG WU	No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan (R.O.C.)	
Signature of Assignor	Date of Signature	
Ying-Cheng Wu	May 24, 2021	
Name of Witness (optional)	Name of Witness (optional)	
Signature of Witness (optional)	Signature of Witness (Optional)	
ASSIGNOR NAME	Address	
CHIEN-MING WU	No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan (R.O.C.)	
Signature of Assignor Chien — Mine Wis	Date of Signature May 24, 2021	
Name of Witness (optional)	Name of Witness (optional)	
Signature of Witness (optional)	Signature of Witness (Optional)	
ASSIGNOR NAME KAI-YIN LIU	Address No. 2, Innovation Road II, Hsinchu Science Park, Hsinchu 300, Taiwan (R.O.C.)	
Signature of Assignor KAL-YUV- (LII)	Date of Signature May 24, 2021	
Name of Witness (optional)	Name of Witness (optional)	
Signature of Witness (optional)	Signature of Witness (Optional)	

PATENT REEL: 056379 FRAME: 0645

**RECORDED: 05/28/2021**